

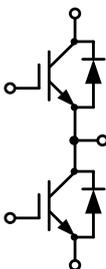
## 34mm Half Bridge IGBT Module

### 电气特性:

- 650V 沟槽栅/场终止工艺
- 低开关损耗
- 正温度系数

### 典型应用:

- 逆变焊机
- 感应加热



$V_{CES}=650V$ ,  $I_{C\ nom}=100A$  /  $I_{CRM}=200A$

## IGBT, 逆变器 / IGBT, Inverter

### 最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
集电极-发射极电压 Collector-Emitter voltage	$T_{vj}=25^{\circ}C$	$V_{CES}$	650	V
连续集电极直流电流 Continuous DC collector current	$T_C=100^{\circ}C$ , $T_{vj\ max}=175^{\circ}C$	$I_{C\ nom}$	100	A
集电极重复峰值电流 Repetitive peak collector current	$t_p=1\ ms$	$I_{CRM}$	200	A
总功率损耗 Total power dissipation	$T_C = 25^{\circ}C$ , $T_{vj\ max} = 175^{\circ}C$	$P_{tot}$	395	W
栅极-发射极电压 Gate emitter voltage		$V_{GE}$	$\pm 20$	V

### 特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
集电极-发射极饱和电压 Collector-Emitter saturation voltage	$V_{GE}=15V$ , $I_C=100A$ $V_{GE}=15V$ , $I_C=100A$	$T_{vj}=25^{\circ}C$ $T_{vj}=150^{\circ}C$	$V_{CESat}$	1.75 2.23	2.4	V
栅极-发射极阈值电压 Gate-Emitter threshold voltage	$I_C = 2.6mA$ , $V_{GE} = V_{CE}$	$T_{vj}=25^{\circ}C$	$V_{GE(th)}$	4.8	5.4 6.0	
栅电荷 Gate charge	$V_{GE}=-15V...+15V$		$Q_G$	0.76		$\mu C$
内部栅极电阻 Internal gate resistor			$R_{Gint}$	none		$\Omega$
输入电容 Input capacitance	$f=1MHz$ , $V_{CE}=25\ V$ , $V_{GE}=0\ V$	$T_{vj}=25^{\circ}C$	$C_{ies}$	8.28		nF

反向传输电容 Reverse transfer capacitance			$C_{res}$		0.15		
集电极-发射极截止电流 Collector-emitter cut-off current	$V_{CE}=650V, V_{GE}=0V$	$T_{vj}=25^{\circ}C$	$I_{CES}$			1	mA
栅极-发射极漏电流 Gate-emitter leakage current	$V_{CE}=0V, V_{GE}=20V$	$T_{vj}=25^{\circ}C$	$I_{GES}$			100	nA
开通延迟时间 Turn-on delay time	$I_C=100A, V_{CE}=400V$ $V_{GE}=\pm 15V, R_G=1.8\Omega$ (电感负载) / (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_{don}$		109 103		ns
上升时间 Rise time	$I_C=100A, V_{CE}=400V$ $V_{GE}=\pm 15V, R_G=1.8\Omega$ (电感负载) / (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_r$		39 40		
关断延迟时间 Turn-off delay time	$I_C=100A, V_{CE}=400V$ $V_{GE}=\pm 15V, R_G=1.8\Omega$ (电感负载) / (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_{doff}$		287 310		
下降时间 Fall time	$I_C=100A, V_{CE}=400V$ $V_{GE}=\pm 15V, R_G=1.8\Omega$ (电感负载) / (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_f$		46 64		
开通损耗能量 (每脉冲) Turn-on energy loss per pulse	$I_C=100A, V_{CE}=400V$ $V_{GE}=\pm 15V, R_G=1.8\Omega$ (电感负载) / (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=150^{\circ}C$	$E_{on}$		1.02 1.19		mJ
关断损耗能量 (每脉冲) Turn-off energy loss per pulse	$I_C=100A, V_{CE}=400V$ $V_{GE}=\pm 15V, R_G=1.8\Omega$ (电感负载) / (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=150^{\circ}C$	$E_{off}$		1.03 1.34		
结-外壳热阻 Thermal resistance, junction to case	每个 IGBT / per IGBT		$R_{thJC}$			0.38	K/W
在开关状态下温度 Temperature under switching conditions			$T_{vj op}$	-40		150	$^{\circ}C$

## 二极管, 逆变器 / Diode, Inverter

### 最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
反向重复峰值电压 Repetitive peak reverse voltage	$T_{vj}=25^{\circ}C$	$V_{RRM}$	650	V
连续正向直流电流 Continuous DC forward current		$I_F$	60	A
正向重复峰值电流 Repetitive peak forward current	$t_p=1ms$	$I_{FRM}$	120	A

### 特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
正向电压 Forward voltage	$I_F=60A, V_{GE}=0V$ $I_F=60A, V_{GE}=0V$	$V_F$		1.45 1.51	2.1	V

反向恢复峰值电流 Peak reverse recovery current	$I_F=60A$ , $-di_F/dt=1557A/\mu s(T_{vj}=150^\circ C)$ $V_R=400V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=150^\circ C$	$I_{RM}$		48 64		A
恢复电荷 Recovered charge	$I_F=60A$ , $-di_F/dt=1557A/\mu s(T_{vj}=150^\circ C)$ $V_R=400V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=150^\circ C$	$Q_F$		1.6 3.1		$\mu C$
反向恢复损耗（每脉冲） Reverse recovered energy	$I_F=60A$ , $-di_F/dt=1557A/\mu s(T_{vj}=150^\circ C)$ $V_R=400V, V_{GE}=-15V$	$T_{vj}=25^\circ C$ $T_{vj}=150^\circ C$	$E_{rec}$		0.44 0.90		mJ
结-外壳热阻 Thermal resistance, junction to case	每个二极管 / per diode		$R_{thJC}$			0.58	K/W
在开关状态下温度 Temperature under switching conditions			$T_{vj op}$	-40		150	$^\circ C$

**模块 / Module**

Parameter	Conditions	Symbol	Value			Unit
绝缘测试电压 Isolation test voltage	RMS, $f=50Hz$ , $t=1min$	$V_{ISOL}$	4000			V
内部绝缘 Internal isolation			Al <sub>2</sub> O <sub>3</sub>			
储存温度 Storage temperature		$T_{stg}$	-40		125	$^\circ C$
模块安装的扭矩 Mounting torque for modul mounting		M	3.0		6.0	Nm
重量 Weight		W		155		g

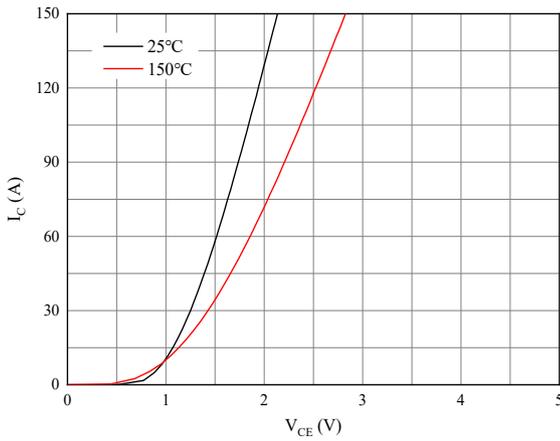


图 1. 典型输出特性 ( $V_{GE}=15V$ )

Figure 1. Typical output characteristics ( $V_{GE}=15V$ )

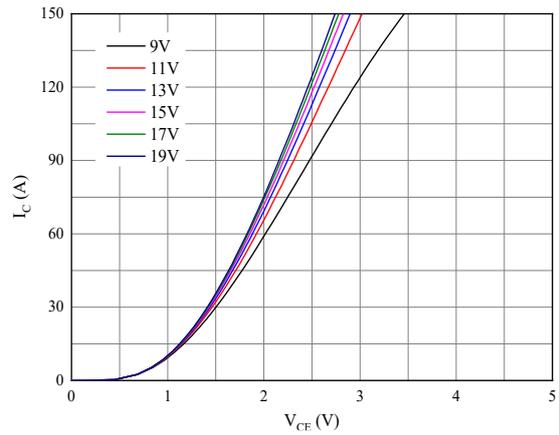


图 2. 典型输出特性 ( $T_{vj}=150^{\circ}C$ )

Figure 2. Typical output characteristics ( $T_{vj}=150^{\circ}C$ )

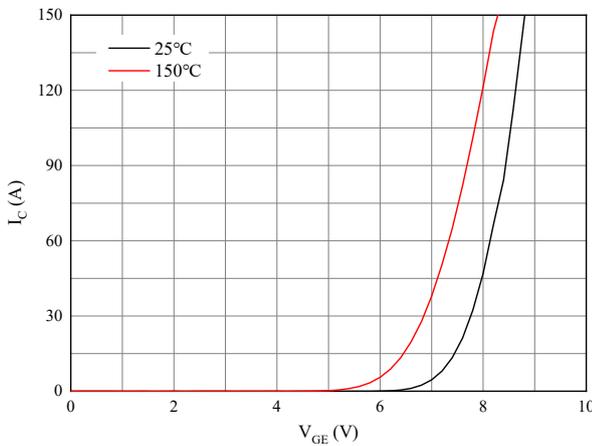


图 3. 典型传输特性( $V_{CE}=20V$ )

Figure 3. Typical transfer characteristic( $V_{CE}=20V$ )

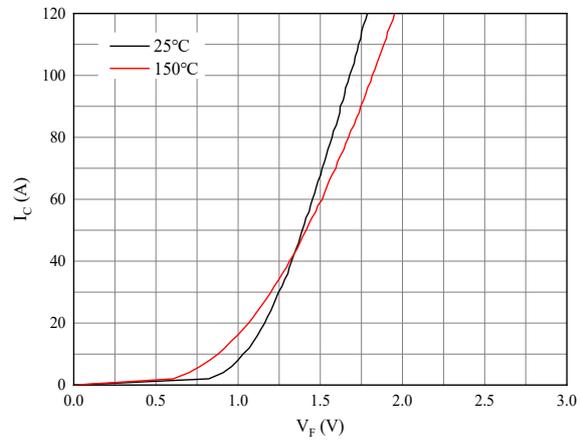


图 4. 正向偏压特性 二极管

Figure 4. Forward characteristic of Diode

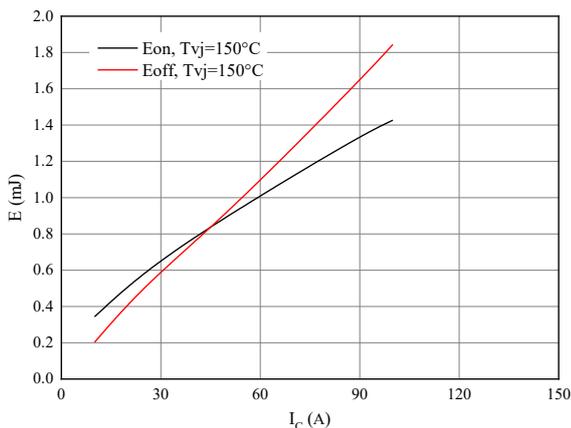


图 5. 开关损耗 逆变器

Figure 5. Switching losses of IGBT  
 $V_{GE}=\pm 15V, R_{Gon}=1.8\Omega, R_{Goff}=1.8\Omega, V_{CE}=400V$

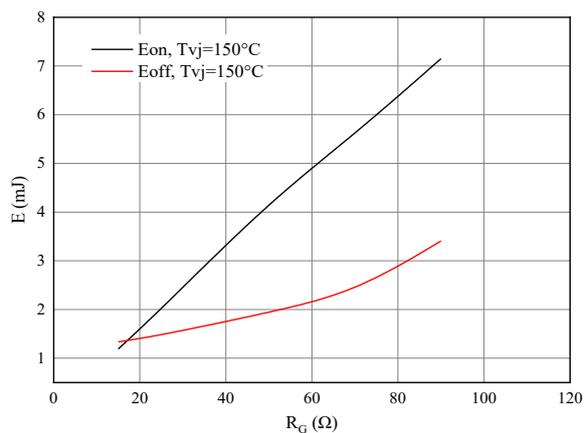


图 6. 开关损耗 逆变器

Figure 6. Switching losses of IGBT  
 $V_{GE}=\pm 15V, I_C=100A, V_{CE}=400V$

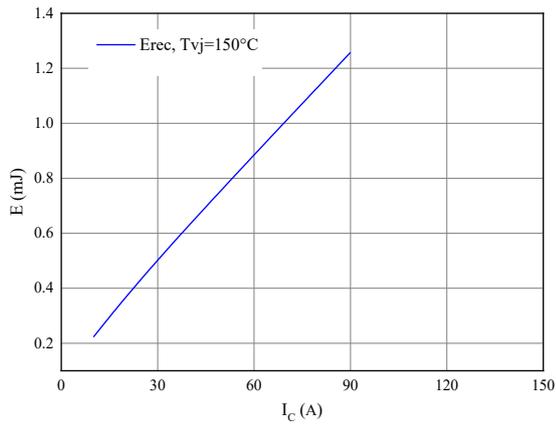


图 7. 开关损耗 二极管

Figure 7. Switching losses of Diode  
 $R_{Gon}=1.8\Omega, V_{CE}=400V$

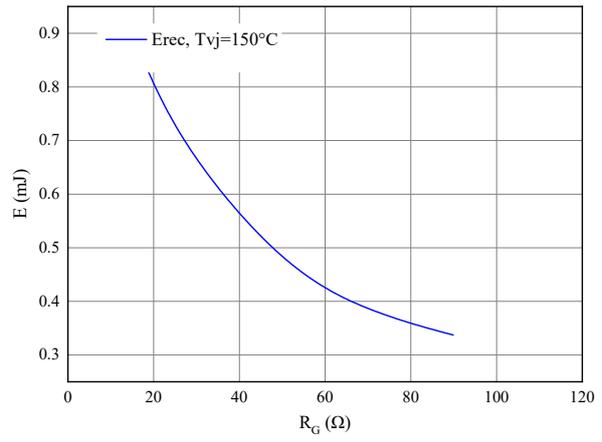


图 8. 开关损耗 二极管

Figure 8. Switching losses of Diode  
 $I_F=60A, V_{CE}=400V$

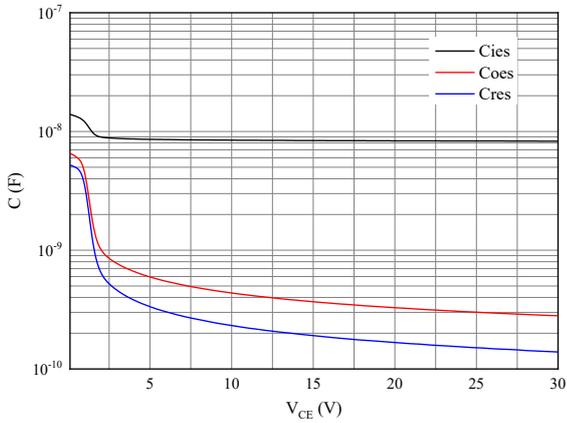
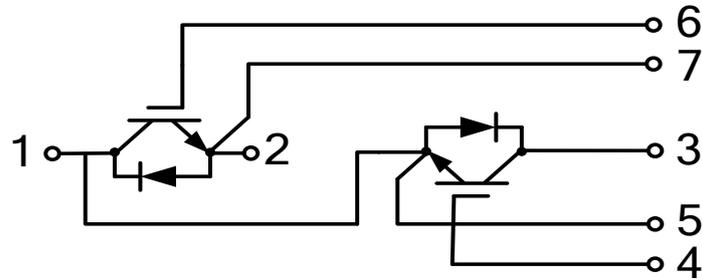


图 9. 电容特性

Figure 9. Capacitance characteristic

接线图 / Circuit diagram



封装尺寸 / Package outlines

